

# 9NM60-U3

**Power MOSFET**

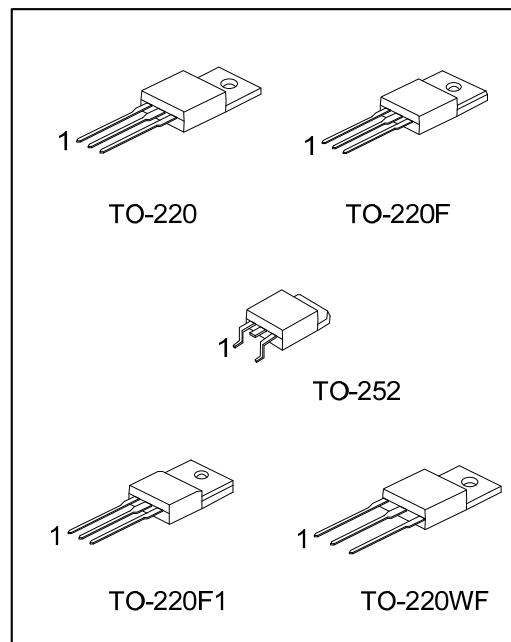
## 9.0A, 600V N-CHANNEL SUPER-JUNCTION MOSFET

### ■ DESCRIPTION

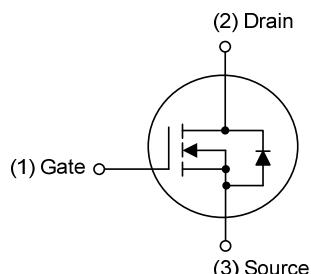
The **UTC 9NM60-U3** is a Super Junction MOSFET Structure and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and a high rugged avalanche characteristics. This power MOSFET is usually used at AC-DC converters for power applications.

### ■ FEATURES

- \*  $R_{DS(ON)} \leq 0.58 \Omega$  @  $V_{GS}=10V$ ,  $I_D=2.0A$
- \* Fast switching capability
- \* Avalanche energy tested
- \* Improved dv/dt capability, high ruggedness



### ■ SYMBOL



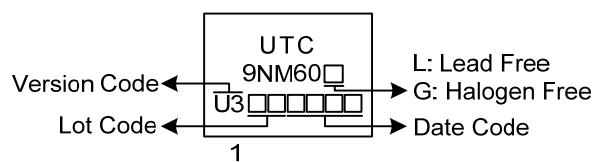
### ■ ORDERING INFORMATION

Ordering Number		Package	Pin Assignment			Packing
Lead Free	Halogen Free		1	2	3	
9NM60L-U3-TA3-T	9NM60G-U3-TA3-T	TO-220	G	D	S	Tube
9NM60L-U3-TF1-T	9NM60G-U3-TF1-T	TO-220F1	G	D	S	Tube
9NM60L-U3-TF3-T	9NM60G-U3-TF3-T	TO-220F	G	D	S	Tube
9NM60L-U3-TW1-T	9NM60G-U3-TW1-T	TO-220WF	G	D	S	Tube
9NM60L-U3-TN3-R	9NM60G-U3-TN3-R	TO-252	G	D	S	Tape Reel

Note: Pin Assignment: G: Gate D: Drain S: Source

	(1) T: Tube, R: Tape Reel (2) TA3: TO-220, TF1: TO-220F1, TF3: TO-220F TW1: TO-220WF, TN3: TO-252 (3) Version U3 (4) G: Halogen Free and Lead Free, L: Lead Free
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## ■ MARKING



■ ABSOLUTE MAXIMUM RATINGS ( $T_c = 25^\circ\text{C}$ , unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		$V_{DSS}$	600	V
Gate-Source Voltage		$V_{GSS}$	$\pm 30$	V
Drain Current	Continuous	$T_c = 25^\circ\text{C}$	$I_D$	9
		$T_c = 100^\circ\text{C}$		5.9
	Pulsed (Note 2)	$I_{DM}$	27	A
Avalanche Energy	Single Pulsed (Note 3)	$E_{AS}$	6.1	mJ
Peak Diode Recovery $dv/dt$ (Note 4)		$dv/dt$	2.1	V/ns
Power Dissipation	TO-220	$P_D$	70	W
	TO-220F/TO-220F1		28	W
	TO-220WF		54	W
	TO-252			
Junction Temperature	$T_J$		+150	$^\circ\text{C}$
Storage Temperature	$T_{STG}$		-55 ~ +150	$^\circ\text{C}$

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating: Pulse width limited by maximum junction temperature.

3.  $L = 100\text{mH}$ ,  $I_{AS} = 0.35\text{A}$ ,  $V_{DD} = 50\text{V}$ ,  $R_G = 25\Omega$  Starting  $T_J = 25^\circ\text{C}$

4.  $I_{SD} \leq 9.0\text{A}$ ,  $di/dt \leq 200\text{A}/\mu\text{s}$ ,  $V_{DD} \leq BV_{DSS}$ , Starting  $T_J = 25^\circ\text{C}$

■ THERMAL DATA

PARAMETER		SYMBOL	RATINGS	UNIT
Junction to Ambient	TO-220/TO-220F	$\theta_{JA}$	62.5	$^\circ\text{C/W}$
	TO-220F1/TO-220WF		110	$^\circ\text{C/W}$
	TO-252			
Junction to Case	TO-220	$\theta_{JC}$	1.8	$^\circ\text{C/W}$
	TO-220F/TO-220F1		4.46	$^\circ\text{C/W}$
	TO-220WF		2.31 (Note)	$^\circ\text{C/W}$
	TO-252			

Note: Device mounted on FR-4 substrate  $P_c$  board, 2oz copper, with 1inch square copper plate.

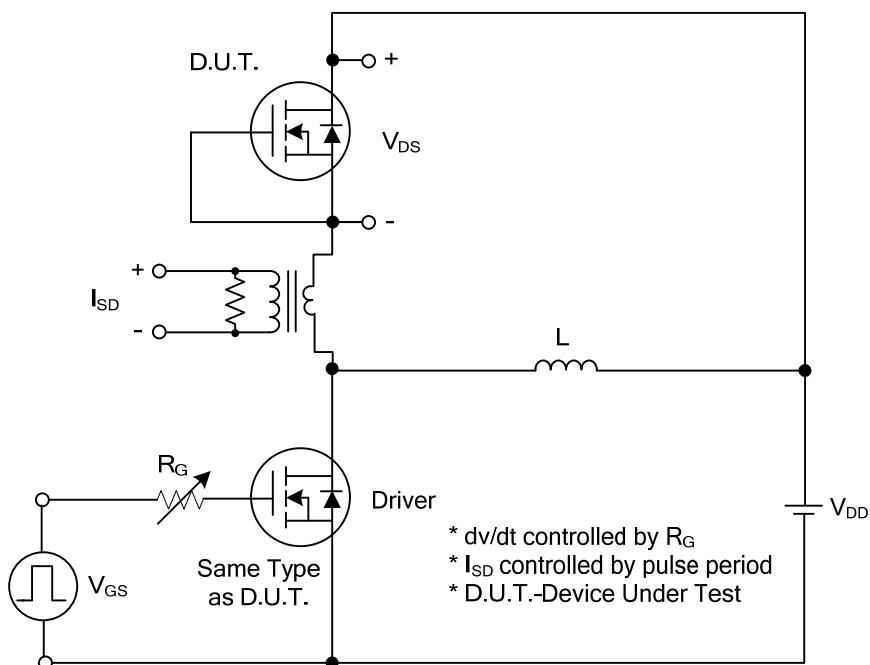
■ ELECTRICAL CHARACTERISTICS ( $T_J = 25^\circ\text{C}$ , unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
<b>OFF CHARACTERISTICS</b>						
Drain-Source Breakdown Voltage	$\text{BV}_{\text{DSS}}$	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=250\mu\text{A}$	600			V
Drain-Source Leakage Current	$I_{\text{DSS}}$	$V_{\text{DS}}=600\text{V}, V_{\text{GS}}=0\text{V}$			10	$\mu\text{A}$
Gate-Source Leakage Current	$I_{\text{GSS}}$	$V_{\text{GS}}=\pm 30\text{V}, V_{\text{DS}}=0\text{V}$			$\pm 100$	nA
<b>ON CHARACTERISTICS</b>						
Gate Threshold Voltage	$V_{\text{GS}(\text{TH})}$	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=250\mu\text{A}$	2.5		4.5	V
Static Drain-Source On-State Resistance	$R_{\text{DS}(\text{ON})}$	$V_{\text{GS}}=10\text{V}, I_{\text{D}}=2.0\text{A}$			0.58	$\Omega$
<b>DYNAMIC CHARACTERISTICS</b>						
Input Capacitance	$C_{\text{ISS}}$	$V_{\text{GS}}=0\text{V}, V_{\text{DS}}=50\text{V}, f=1\text{MHz}$		404		pF
Output Capacitance	$C_{\text{OSS}}$			136		pF
Reverse Transfer Capacitance	$C_{\text{RSS}}$			7		pF
<b>SWITCHING CHARACTERISTICS</b>						
Total Gate Charge (Note 1)	$Q_G$	$V_{\text{DS}}=480\text{V}, V_{\text{GS}}=10\text{V}, I_{\text{D}}=9.0\text{A}$ (Note 1, 2)		24		nC
Gate-Source Charge	$Q_{\text{GS}}$			8		nC
Gate-Drain Charge	$Q_{\text{DD}}$			8		nC
Turn-On Delay Time (Note 1)	$t_{\text{D}(\text{ON})}$	$V_{\text{DD}}=100\text{V}, V_{\text{GS}}=10\text{V}, I_{\text{D}}=9.0\text{A},$ $R_{\text{G}}=25\Omega$ (Note 1, 2)		8		ns
Turn-On Rise Time	$t_R$			25		ns
Turn-Off Delay Time	$t_{\text{D}(\text{OFF})}$			49		ns
Turn-Off Fall Time	$t_F$			27		ns
<b>SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS</b>						
Maximum Continuous Drain-Source Diode Forward Current	$I_S$				9	A
Maximum Pulsed Drain-Source Diode Forward Current	$I_{\text{SM}}$				27	A
Drain-Source Diode Forward Voltage (Note 1)	$V_{\text{SD}}$	$I_S=9.0\text{A}, V_{\text{GS}}=0\text{V}$			1.4	V
Body Diode Reverse Recovery Time (Note 1)	$t_{\text{rr}}$	$I_S=9.0\text{A}, V_{\text{GS}}=0\text{V},$ $dI_F/dt=100\text{A}/\mu\text{s}$		285		nS
Body Diode Reverse Recovery Charge	$Q_{\text{rr}}$			3193		nC

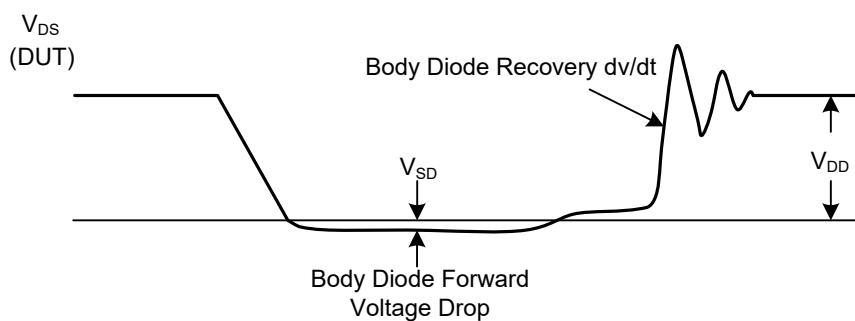
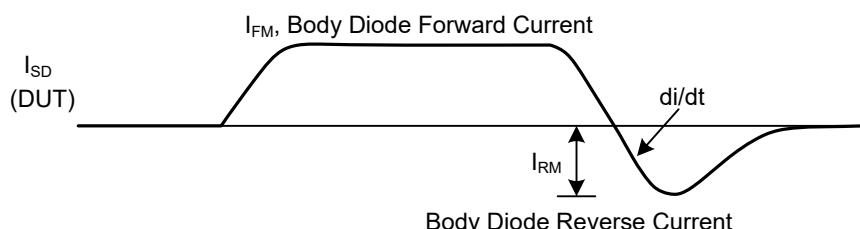
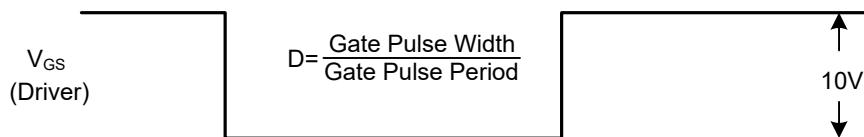
Notes: 1. Pulse Test: Pulse width  $\leq 300\mu\text{s}$ , Duty cycle  $\leq 2\%$ .

2. Essentially independent of operating temperature.

■ TEST CIRCUITS AND WAVEFORMS

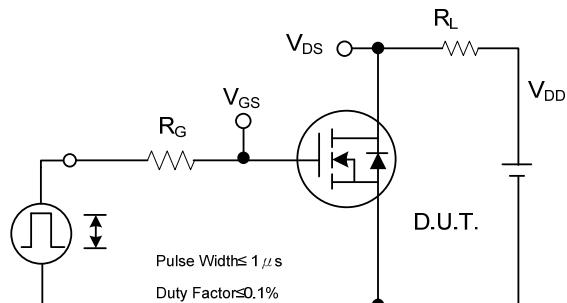


Peak Diode Recovery  $dv/dt$  Test Circuit

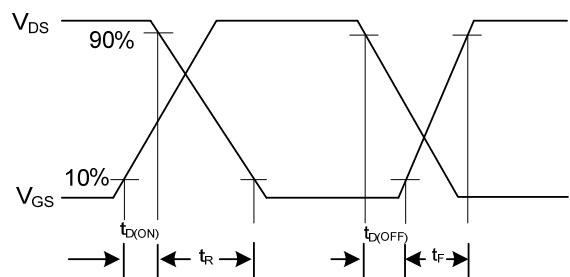


Peak Diode Recovery  $dv/dt$  Waveforms

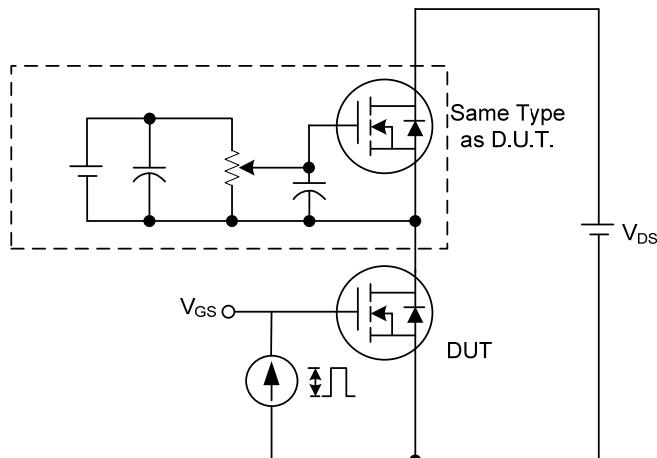
### ■ TEST CIRCUITS AND WAVEFORMS



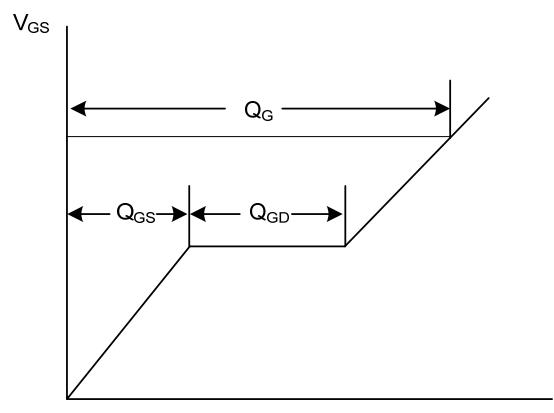
Switching Test Circuit



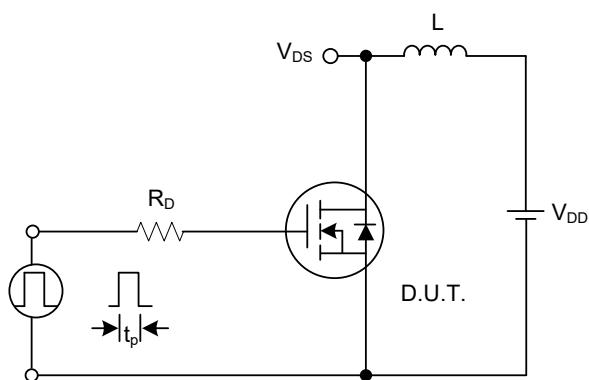
Switching Waveforms



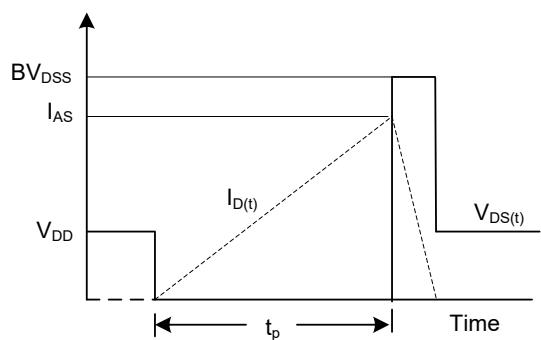
Gate Charge Test Circuit



Gate Charge Waveform

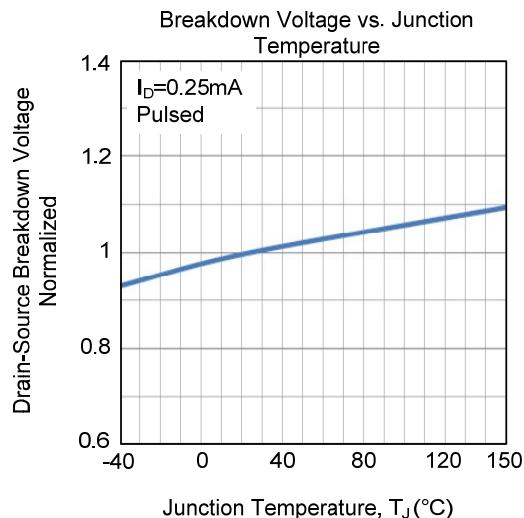
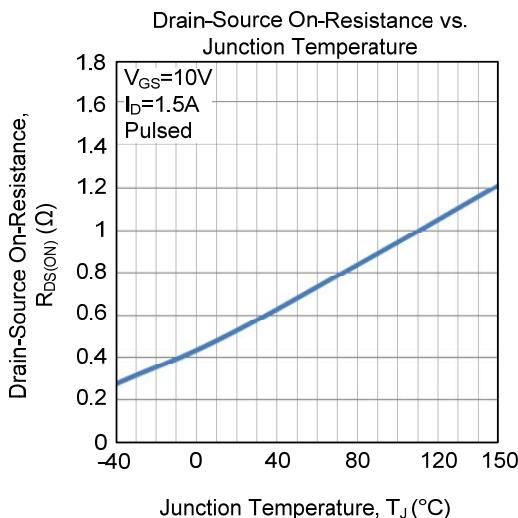
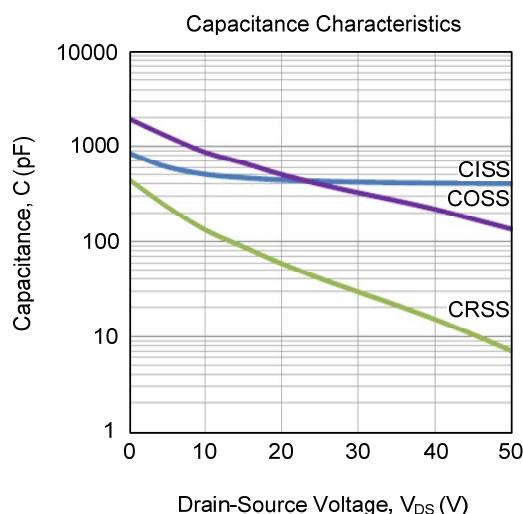
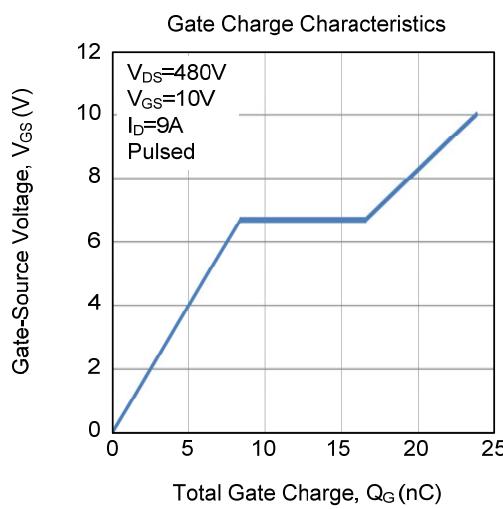
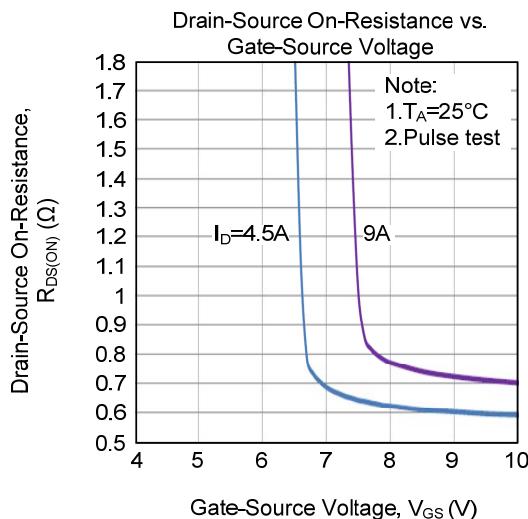
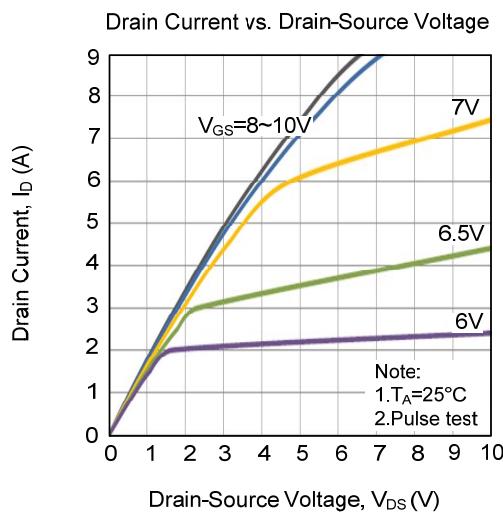


Unclamped Inductive Switching Test Circuit

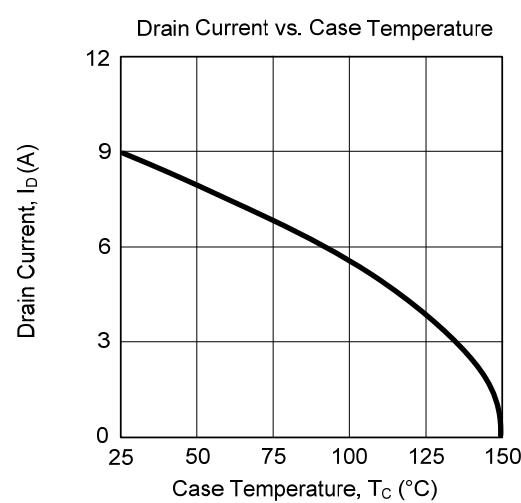
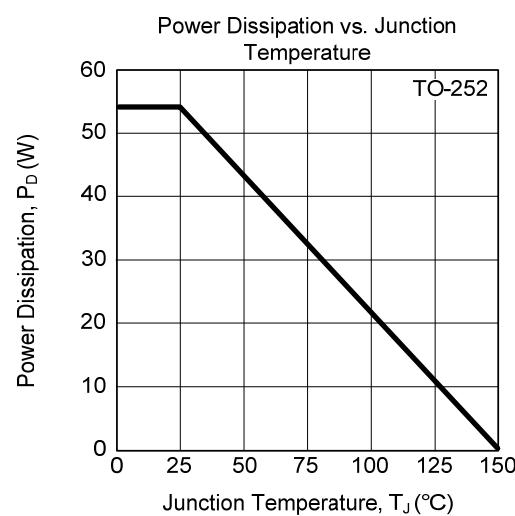
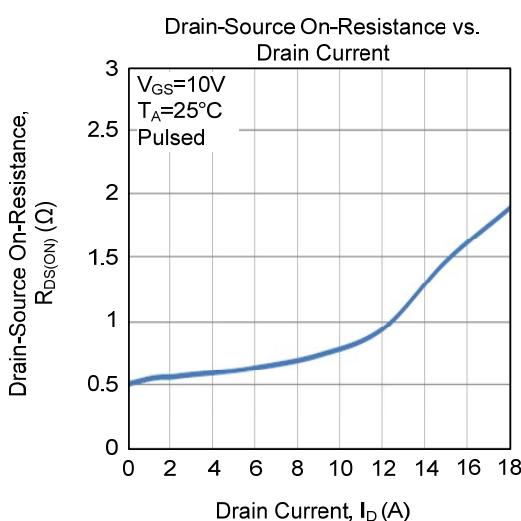
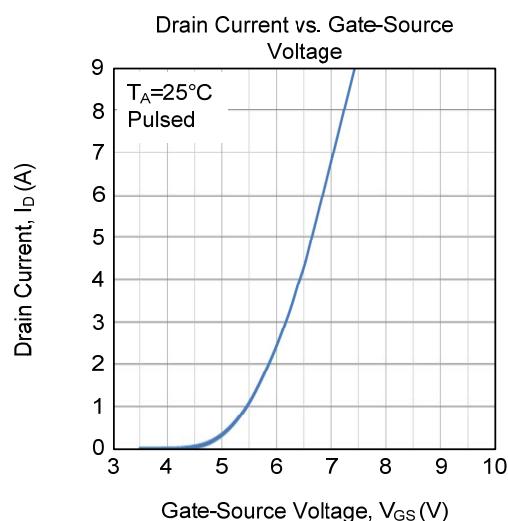
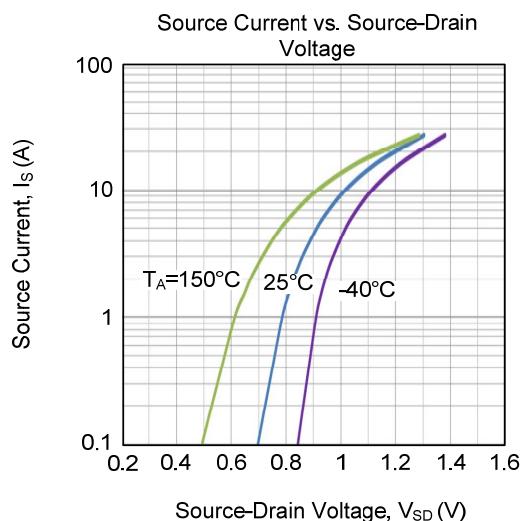
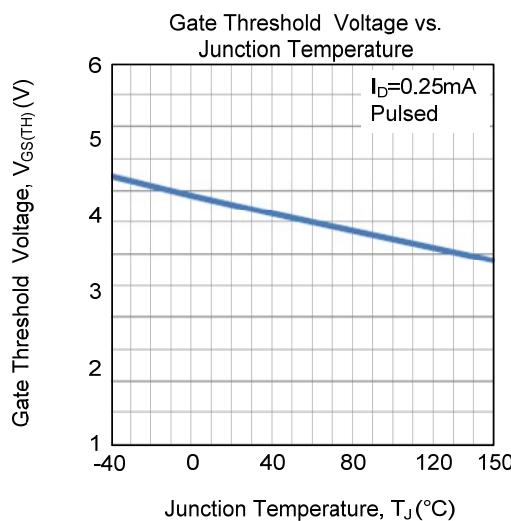


Unclamped Inductive Switching Waveforms

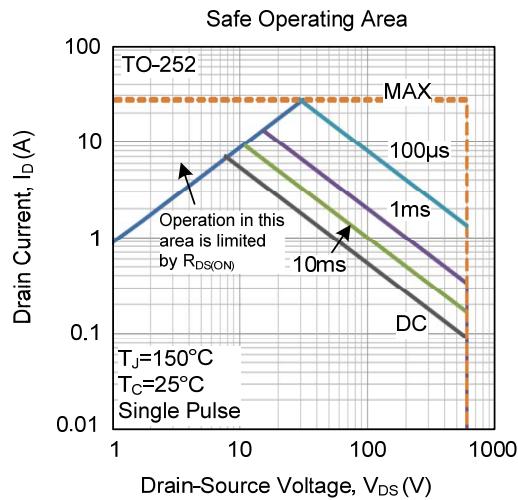
■ TYPICAL CHARACTERISTICS



## ■ TYPICAL CHARACTERISTICS (Cont.)



- TYPICAL CHARACTERISTICS (Cont.)



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